



PATENTS
112055-0040P1
17732-38560.001

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re The Application of:
David Chong Sook Lim et al.)
Serial No.: 10/664,982)
Filed: September 17, 2003)
For: PACKAGING SYSTEM FOR DIE-)
UP CONNECTION OF A DIE-DOWN)
ORIENTED INTEGRATED CIRCUIT)

Cesari and McKenna, LLP
88 Black Falcon Avenue
Boston, MA 02210
September 7, 2005

“Express Mail” Mailing-Label Number: EV432397743US

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

In response to the Office action dated 05/20/2005, please find a request for an extension of one month and the corresponding fee. Please enter the following amendments: